Filename: BOM PMP10572
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PMP10572

PackageReference Designator Quantity Value Description PartNumber Manufacturer 10uF CAP, CERM, 10uF, 16V, +/-10%, X7R, 0805 C2012X5R1E106K125A TDK C1, C10, 3 0805 C11 GRM31CR61E106KA12 C2 10uF CAP, CERM, 10uF, 25V, +/-10%, X5R, 1206 1206 MuRata 1 C3 1 100pF CAP, CERM, 100pF, 1000V, +/-5%, U2J, 1206 1206 GRM31A7U3A101JW31 MuRata CAP, CERM, 1500pF, 50V, +/-5%, C0G/NP0, 0603 C4. C9 1500pF 0603 C1608C0G1H152J 2 TDK CAP, CERM, 0.01uF, 16V, +/-10%, X7R, 0603 GRM188R71C103KA01 C5, C22 2 0.01uF 0603 MuRata C6 2.2uF CAP, CERM, 2.2uF, 100V, +/-10%, X7R, 1210 1210 C3225X7R2A225K230A TDK 1 C2012X7R2A104K C8, C21, 0.1uF CAP, CERM, 0.1uF, 100V, +/-10%, X7R, 0805 0805 TDK 3 C23 C12 1uF CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603 0603 GRM188R61C105KA93 MuRata 1 GRM188R71C223KA01 C13 0.022uF CAP, CERM, 0.022uF, 16V, +/-10%, X7R, 0603 0603 MuRata 1 C15 68uF CAP, AL, 68uF, 6.3V, +/-20%, 1 ohm, SMD SMT Radial D EEE-FC0J680P Panasonio CAP, AL, 10uF, 63V, +/-20%, 120 ohm, SMD EEHZA1J100P C25 10uF 6.3x5.8 Panasonio CAP, CERM, 100pF, 100V, +/-5%, C0G/NP0, 0603 C1608C0G2A101J 100pl TDK Cs 0603 D1 100V Diode, Schottky, 100V, 2A, SMB SMB B2100-13-F Diodes Inc D2 Diode, Schottky, 100V, 1A, PowerDI123 PowerDI123 DFLS1100-7 100V 1 Diodes Inc Diode, Switching-Bridge, 100V, 0.8A, MiniDIP MiniDIF HD01-T D10, D11 100V Diodes Inc Diode, TVS, Uni, 60V, 400W, SMA SMAJ60A D21 60V SMA _ittelfuse Diode, Schottky, 100V, 1A, SMA D30 100V B1100-13-F Diodes Inc Header, 100mil, 4x1, Tin, TH Header, 4x1, 100mil, 826631-4 TE Connectivity J1 1 J3 Header, 100mil, 6x1, Tin, TH Header,6x1, 100mil, 826631-6 TE Connectivity 1 R2 1.27k RES, 1.27k ohm, 1%, 0.125W, 0805 0805 ERJ-6ENF1271V 1 Panasonic R4 51.1k RES, 51.1k ohm, 1%, 0.1W, 0603 0603 RC0603FR-0751K1L 1 Yageo America R5 10.0 RES, 10.0 ohm, 1%, 0.1W, 0603 CRCW060310R0FKEA 0603 Vishay-Dale R6 1 49.9k RES, 49.9k ohm, 0.1%, 0.1W, 0603 0603 RG1608P-4992-B-T5 Susumu Co Ltd R7 RES, 442k ohm, 1%, 0.1W, 0603 CRCW0603442KFKEA 442k 0603 Vishav-Dale RES, 46.4k ohm, 1%, 0.1W, 0603 R8 46.4k 0603 CRCW060346K4FKEA 1 Vishay-Dale R9 RES, 10k ohm, 5%, 0.1W, 0603 0603 CRCW060310K0JNEA 10k Vishay-Dale R10 2.05k RES, 2.05k ohm, 1%, 0.125W, 0805 0805 ERJ-6ENF2051V 1 Panasonic R21 RES, 24.9k ohm, 1%, 0.1W, 0603 CRCW060324K9FKEA 24.9k 0603 Vishay-Dale RES, 10k ohm, 5%, 0.1W, 0603 R22 1 10k 0603 RC0603JR-0710KL Yageo America R23 RES, 237k ohm, 0.1%, 0.1W, 0603 RT0603BRD07237KL 237k 0603 Yageo America R25 1 90.9 RES, 90.9 ohm, 1%, 0.1W, 0603 0603 CRCW060390R9FKEA Vishay-Dale R29 RES, 0 ohm, 5%, 0.1W, 0603 0603 CRCW06030000Z0EA Vishay-Dale Rs 5.11 RES, 5.11 ohm, 1%, 0.125W, 0805 0805 CRCW08055R11FKEA Vishay-Dale Power over Ethernet Transformer MNC-Tech, EP-EP10 EP-1021SG MNC-Tech 1021SG U1 PWM, COT Controller DNT0012B LM5160A Texas Instruments 1 U2 IEEE 802.3at PoE High-Power PD Interface, TPS2378DDA 1 DDA0008E Texas Instruments C31 CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603 C1608X7R1C105K 0 1uF 0603 TDK C35 0 0.1uF CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603 0603 GRM188R71H104KA93 MuRata R27 4.99k RES, 4.99k ohm, 1%, 0.1W, 0603 0603 CRCW06034K99FKEA 0 Vishay-Dale RES, 2.26k ohm, 1%, 0.1W, 0603 CRCW06032K26FKEA R28 0 2.26k 0603 Vishay-Dale CRCW060310R0JNEA 0 10 RES, 10 ohm, 5%, 0.1W, 0603 0603 Vishay-Dale R32 RES, 10.0k ohm, 1%, 0.1W, 0603 CRCW060310K0FKEA 0 10.0k 0603 Vishay-Dale RES, 40.2k ohm, 1%, 0.1W, 0603 CRCW060340K2FKEA R35 0 40.2k 0603 Vishay-Dale RES, 41.2k ohm, 1%, 0.1W, 0603 CRCW060341K2FKEA R36 0 41.2k 0603 Vishay-Dale 0 10.0K RES, 3.01k ohm, 1%, 0.1W, 0603 CRCW06033K01FKEA Vishay-Dale U3 Low-Voltage (1.24V) Adjustable Precision Shunt MF05A LMV431ACM5 0 National Semiconductor Regulator, 5-pin SOT-23 U4 0 High Isolation Voltage Single Transistor Type PS2501L PS2501L-1-A California Eastern Laboratories

Notes

OptoCoupler

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